



Phase Control Thyristor

DS5879-4 December 2016 (LN36494)

FEATURES

- Double Side Cooling
- High Surge Capability

KEY PARAMETERS

V _{DRM}	5200V
I _{T(AV)}	1845A
I _{TSM}	26250A
dV/dt*	1500V/µs
dl/dt	300A/µs

* Higher dV/dt selections available

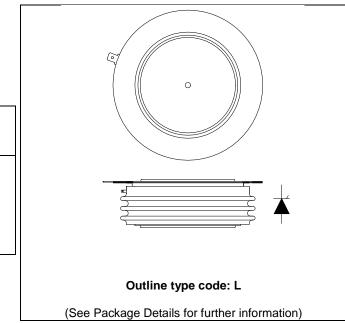


Fig. 1 Package outline

APPLICATIONS

- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{DRM} and V _{RRM} V	Conditions
DCR1850L52* DCR1850L50 DCR1850L48	5200 5000 4800	$\begin{array}{l} T_{vj} = -40^{\circ}C \text{ to } 125^{\circ}C, \\ I_{DRM} = I_{RRM} = 300\text{mA}, \\ V_{DRM}, V_{RRM} t_p = 10\text{ms}, \\ V_{DSM} \& V_{RSM} = \\ V_{DRM} \& V_{RRM} + 100\text{V} \\ \text{respectively} \end{array}$

Lower voltage grades available. * 5000V @ -40° C, 5200V @ 0° C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR1850L52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.



CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Sid	de Cooled			
I _{T(AV)}	Mean on-state current	Half wave resistive load	1845	А
I _{T(RMS)}	RMS value	-	2898	А
Ι _Τ	Continuous (direct) on-state current	-	2719	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}C$	26.25	kA
l ² t	I ² t for fusing	$V_R = 0$	3.45	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Condition	S	Min.	Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC	-	0.0117	°C/W
		Single side cooled	Anode DC	-	0.0187	°C/W
			Cathode DC	-	0.0329	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Clamping force 37kN	Double side	-	0.0025	°C/W
		(with mounting compound)	Single side	-	0.005	°C/W
T_{vj}	Virtual junction temperature	Blocking V _{DRM} / _{VRRM}		-	125	°C
T _{stg}	Storage temperature range			-55	125	°C
F _m	Clamping force			33.0	41.0	kN

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DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditio	ns	Min.	Max.	Units
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C	At V _{RRM} /V _{DRM} , T _{case} = 125°C		300	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V_{DRM} to 2x $I_{\text{T(AV)}}$	Repetitive 50Hz	-	150	A/µs
		Gate source 30V, 10Ω ,	Non-repetitive	-	300	A/µs
		$t_r < 0.5 \mu s, T_j = 125^{\circ}C$				
V _{T(TO)}	Threshold voltage – Low level	500A to 2000A at $T_{case} = 125$	5°C	-	0.932	V
	Threshold voltage – High level	2000A to 7000A at T _{case} = 125°C		-	1.100	V
r _T	On-state slope resistance – Low level	500A to 2000A at T _{case} = 125°C		-	0.434	mΩ
	On-state slope resistance – High level	2000A to 7000A at $T_{case} = 125^{\circ}C$		-	0.346	mΩ
t _{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source	30V, 10Ω	-	3	μs
		$t_r=0.5\mu s,T_j=25^\circ C$				
tq	Turn-off time	$T_j = 125^{\circ}C, V_R = 200V, dI/dt$	= 1A/µs,	700	1100	μs
		$dV_{DR}/dt = 20V/\mu s$ linear				
Q_S	Stored charge	$I_T = 2000A, T_j = 125^{\circ}C, dI/dt - 1A/\mu s,$		1200	2800	μC
١L	Latching current	$T_j = 25^{\circ}C, V_D = 5V$		-	3	А
Ι _Η	Holding current	$T_j = 25^{\circ}C, R_{G-K} = \infty, I_{TM} = 500A, I_T = 5A$		-	300	mA

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GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V _{GT}	Gate trigger voltage	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	1.5	V
V_{GD}	Gate non-trigger voltage	At 50% V _{DRM} , T _{case} = 125°C	0.4	V
I _{GT}	Gate trigger current	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	350	mA
I _{GD}	Gate non-trigger current	At 50% V _{DRM} , T _{case} = 125°C	15	mA

CURVES

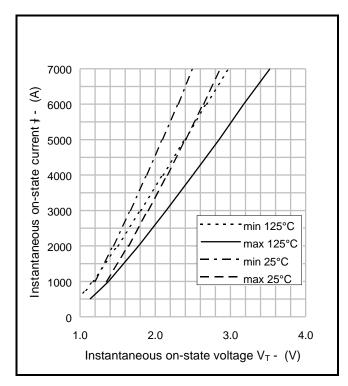


Fig.2 Maximum & minimum on-state characteristics

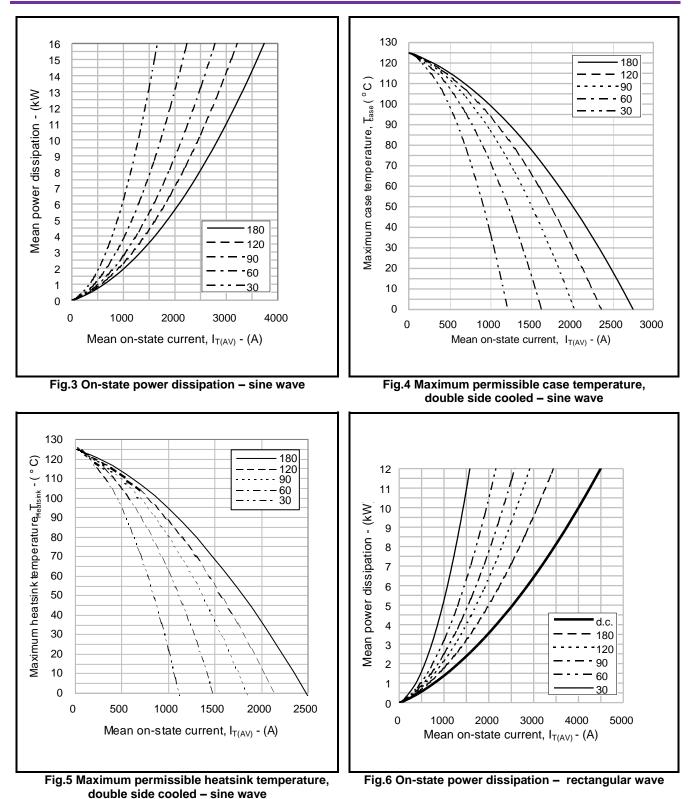
V_{TM} EQUATION

$$V_{TM} = A + Bln (I_T) + C.I_T + D.\sqrt{I_T}$$

Where A = -0.142705 B = 0.203033 C = 0.000358 D = -0.00751 these values are valid for T_j = 125°C for $I_{\rm T}$ 100A to 7200A



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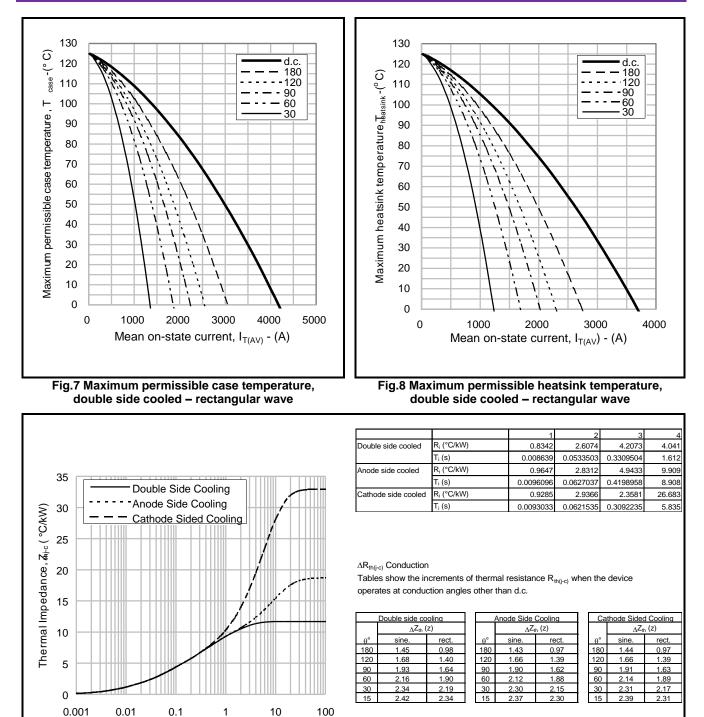


Fig.9 Maximum (limit) transient thermal impedance – junction to case (°C/kW)

Time (s)

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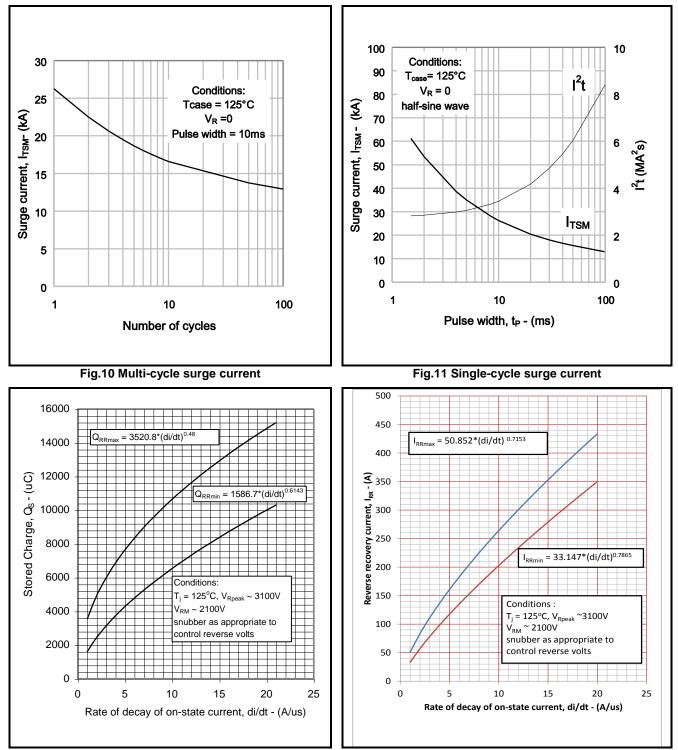


Fig.12 Stored Charge

Fig.13 Reverse recovery current



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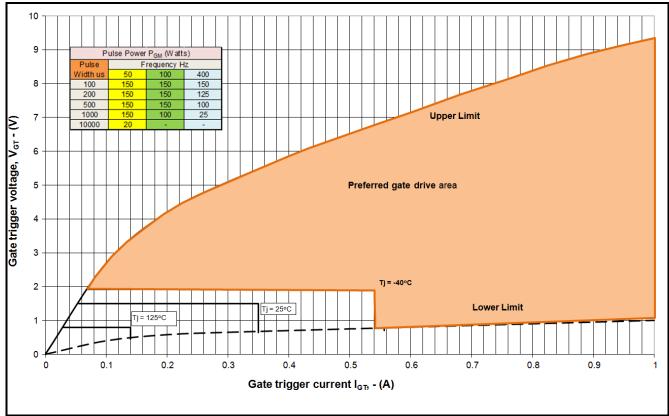


Fig14 Gate Characteristics

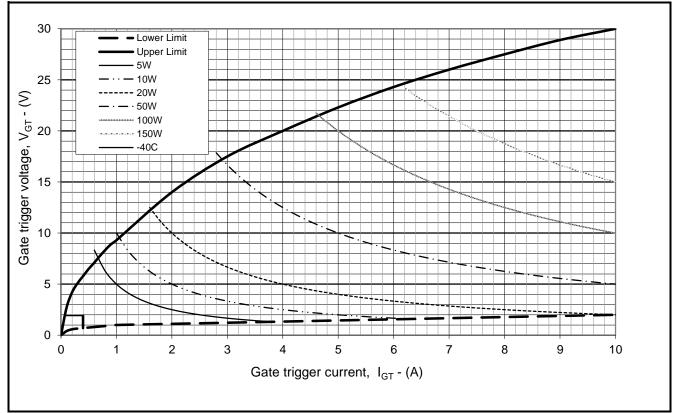


Fig. 15 Gate characteristics



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PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

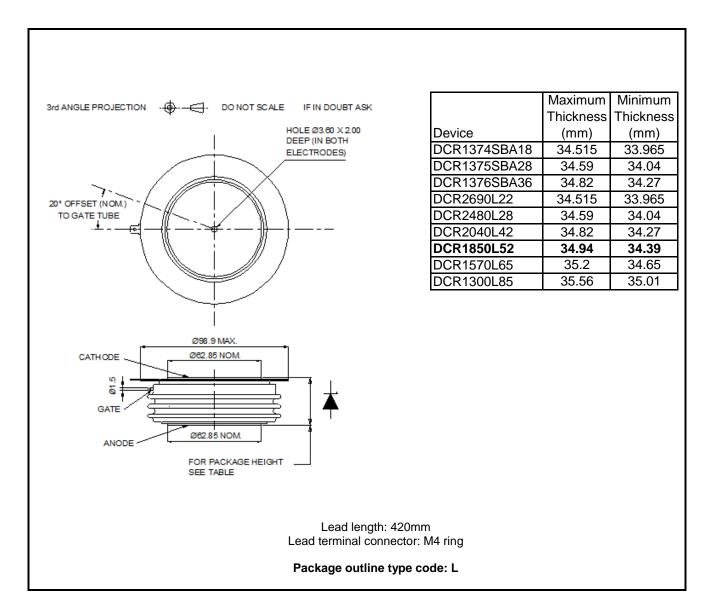


Fig.16 Package outline



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